



May 1999
Revised May 1999

74LVT373 • 74LVTH373

Low Voltage Octal Transparent Latch with 3-STATE Outputs (Preliminary)

General Description

The LVT373 and LVTH373 consist of eight latches with 3-STATE outputs for bus organized system applications. The latches appear transparent to the data when Latch Enable (LE) is HIGH. When LE is LOW, the data satisfying the input timing requirements is latched. Data appears on the bus when the Output Enable (\overline{OE}) is LOW. When \overline{OE} is HIGH, the bus output is in a high impedance state.

The LVTH373 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These octal latches are designed for low-voltage (3.3V) V_{CC} applications, but with the capability to provide a TTL interface to a 5V environment. The LVT373 and LVTH373 are fabricated with an advanced BiCMOS technology to

achieve high speed operation similar to 5V ABT while maintaining low power dissipation.

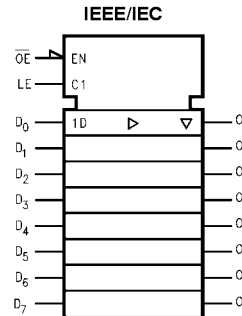
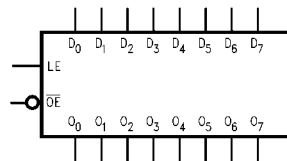
Features

- Input and output interface capability to systems at 5V V_{CC}
- Bus-Hold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH373), also available without bushold feature (74LVT373).
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- Outputs source/sink -32 mA/+64 mA
- Functionally compatible with the 74 series 373

Ordering Code:

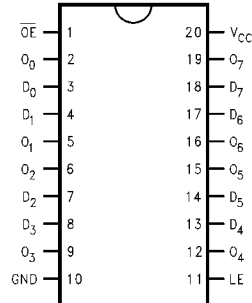
| Order Number | Package Number | Package Description |
|--------------|----------------|---|
| 74LVT373WM | M20B | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide |
| 74LVT373SJ | M20D | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide |
| 74LVT373MSA | MSA20 | 20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide |
| 74LVT373MTC | MTC20 | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |
| 74LVTH373WM | M20B | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide |
| 74LVTH373SJ | M20D | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide |
| 74LVTH373MSA | MSA20 | 20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide |
| 74LVTH373MTC | MTC20 | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |

Logic Symbols



74LVT373 • 74LVTH373 Low Voltage Octal Transparent Latch with 3-STATE Outputs (Preliminary)

Connection Diagram



Pin Descriptions

| Pin Names | Description |
|--------------------------------|-----------------------|
| D ₀ -D ₇ | Data Inputs |
| LE | Latch Enable Input |
| \overline{OE} | Output Enable Input |
| O ₀ -O ₇ | 3-STATE Latch Outputs |

Truth Table

| LE | Inputs | | O _n |
|----|-----------------|----------------|----------------|
| | \overline{OE} | D _n | |
| X | H | X | Z |
| H | L | L | L |
| H | L | H | H |
| L | L | X | O ₀ |

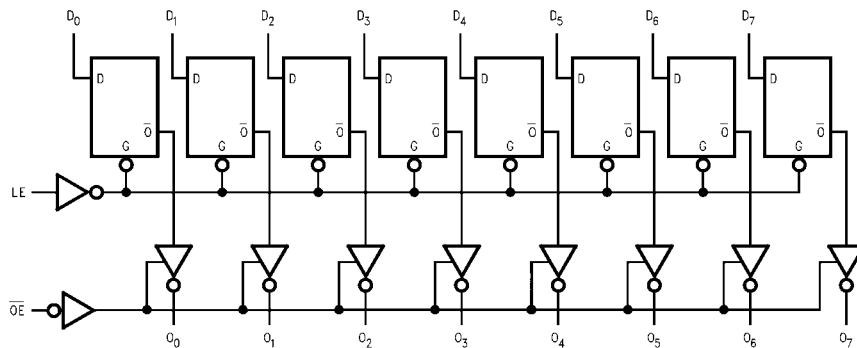
H = HIGH Voltage Level
 L = LOW Voltage Level
 Z = High Impedance
 X = Immaterial
 O₀ = Previous O₀ before HIGH-to-LOW transition of Latch Enable

Functional Description

The LVT373 and LVTH373 contain eight D-type latches with 3-STATE standard outputs. When the Latch Enable (LE) input is HIGH, data on the D_n inputs enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW, the latches store the information that was present on the D inputs a setup time preced-

ing the HIGH-to-LOW transition of LE. The 3-STATE standard outputs are controlled by the Output Enable (\overline{OE}) input. When \overline{OE} is LOW, the standard outputs are in the 2-state mode. When \overline{OE} is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the latches.

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

| Absolute Maximum Ratings (Note 1) | | | | |
|-----------------------------------|----------------------------------|--------------|--------------------------------------|-------------|
| Symbol | Parameter | Value | Conditions | Units |
| V_{CC} | Supply Voltage | -0.5 to +4.6 | | V |
| V_I | DC Input Voltage | -0.5 to +7.0 | | V |
| V_O | DC Output Voltage | -0.5 to +7.0 | Output in 3-STATE | V |
| | | -0.5 to +7.0 | Output in HIGH or LOW State (Note 2) | V |
| I_{IK} | DC Input Diode Current | -50 | $V_I < GND$ | mA |
| I_{OK} | DC Output Diode Current | -50 | $V_O < GND$ | mA |
| I_O | DC Output Current | 64 | $V_O > V_{CC}$ Output at HIGH State | mA |
| | | 128 | $V_O > V_{CC}$ Output at LOW State | |
| I_{CC} | DC Supply Current per Supply Pin | ± 64 | | mA |
| I_{GND} | DC Ground Current per Ground Pin | ± 128 | | mA |
| T_{STG} | Storage Temperature | -65 to +150 | | $^{\circ}C$ |

| Recommended Operating Conditions | | | | |
|----------------------------------|---|-----|-----|-------------|
| Symbol | Parameter | Min | Max | Units |
| V_{CC} | Supply Voltage | 2.7 | 3.6 | V |
| V_I | Input Voltage | 0 | 5.5 | V |
| I_{OH} | HIGH Level Output Current | | -32 | mA |
| I_{OL} | LOW Level Output Current | | 64 | mA |
| T_A | Free-Air Operating Temperature | -40 | 85 | $^{\circ}C$ |
| $\Delta t/\Delta V$ | Input Edge Rate, $V_{IN} = 0.8V-2.0V$, $V_{CC} = 3.0V$ | 0 | 10 | ns/V |

Note 1: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.

Note 2: I_O Absolute Maximum Rating must be observed.

| DC Electrical Characteristics | | | | | | | | |
|-------------------------------|---|---------------------|---------------------------------|--------------|------|-------|---|--|
| Symbol | Parameter | V _{CC} (V) | T _A = -40°C to +85°C | | | Units | Conditions | |
| | | | Min | Typ (Note 3) | Max | | | |
| V _{IK} | Input Clamp Diode Voltage | 2.7 | | | -1.2 | V | I _I = -18 mA | |
| V _{IH} | Input HIGH Voltage | 2.7-3.6 | 2.0 | | | V | V _O ≤ 0.1V or V _O ≥ V _{CC} - 0.1V | |
| V _{IL} | Input LOW Voltage | 2.7-3.6 | | | 0.8 | | | |
| V _{OH} | Output HIGH Voltage | 2.7-3.6 | V _{CC} - 0.2 | | | V | I _{OH} = -100 μA | |
| | | 2.7 | 2.4 | | | V | I _{OH} = -8 mA | |
| | | 3.0 | 2.0 | | | V | I _{OH} = -32 mA | |
| V _{OL} | Output LOW Voltage | 2.7 | | | 0.2 | V | I _{OL} = 100 μA | |
| | | 2.7 | | | 0.5 | V | I _{OL} = 24 mA | |
| | | 3.0 | | | 0.4 | V | I _{OL} = 16 mA | |
| | | 3.0 | | | 0.5 | V | I _{OL} = 32 mA | |
| | | 3.0 | | | 0.55 | V | I _{OL} = 64 mA | |
| I _{I(HOLD)} (Note 4) | Bus-Hold Input Minimum Drive | 3.0 | 75 | | | μA | V _I = 0.8V | |
| | | | -75 | | | μA | V _I = 2.0V | |
| I _{I(OD)} (Note 4) | Bus-Hold Input Over-Drive Current to Change State | 3.0 | 500 | | | μA | (Note 5) | |
| | | | -500 | | | μA | (Note 6) | |
| I _I | Input Current | 3.6 | | | 10 | μA | V _I = 5.5V | |
| | | | Control Pins | | | ±1 | μA | V _I = 0V or V _{CC} |
| | | | Data Pins | | | -5 | μA | V _I = 0V |
| | | | | | | 1 | μA | V _I = V _{CC} |
| I _{OFF} | Power Off Leakage Current | 0 | | | ±100 | μA | 0V ≤ V _I or V _O ≤ 5.5V | |
| I _{PU/PD} | Power up/down 3-STATE Output Current | 0-1.5V | | | ±100 | μA | V _O = 0.5V to 3.0V V _I = GND or V _{CC} | |
| I _{OZL} | 3-STATE Output Leakage Current | 3.6 | | | -5 | μA | V _O = 0.5V | |
| I _{OZH} | 3-STATE Output Leakage Current | 3.6 | | | 5 | μA | V _O = 3.0V | |
| I _{OZH+} | 3-STATE Output Leakage Current | 3.6 | | | 10 | μA | V _{CC} < V _O ≤ 5.5V | |
| I _{CCH} | Power Supply Current | 3.6 | | | 0.19 | mA | Outputs HIGH | |
| I _{CCL} | Power Supply Current | 3.6 | | | 5 | mA | Outputs LOW | |
| I _{CCZ} | Power Supply Current | 3.6 | | | 0.19 | mA | Outputs Disabled | |
| I _{CCZ+} | Power Supply Current | 3.6 | | | 0.19 | mA | V _{CC} ≤ V _O ≤ 5.5V, Outputs Disabled | |
| ΔI _{CC} | Increase in Power Supply Current (Note 7) | 3.6 | | | 0.2 | mA | One Input at V _{CC} - 0.6V Other Inputs at V _{CC} or GND | |

Note 3: All typical values are at V_{CC} = 3.3V, T_A = 25°C.

Note 4: Applies to Bushold versions only (74LVTH373).

Note 5: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 6: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 7: This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

Dynamic Switching Characteristics (Note 8)

| Symbol | Parameter | V _{CC} (V) | T _A = 25°C | | | Units | Conditions C _L = 50 pF R _L = 500Ω |
|------------------|--|---------------------|-----------------------|------|-----|-------|---|
| | | | Min | Typ | Max | | |
| V _{OLP} | Quiet Output Maximum Dynamic V _{OL} | 3.3 | | 0.8 | | V | (Note 9) |
| V _{OLV} | Quiet Output Minimum Dynamic V _{OL} | 3.3 | | -0.8 | | V | (Note 9) |

Note 8: Characterized in SOIC package. Guaranteed parameter, but not tested.

Note 9: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

| AC Electrical Characteristics | | | | | | | |
|-------------------------------|----------------------------------|--|------------------|-----|------------------------|-----|-------|
| Symbol | Parameter | T _A = -40°C to +85°C C _L = 50 pF, R _L = 500Ω | | | | | Units |
| | | V _{CC} = 3.3V ±0.3V | | | V _{CC} = 2.7V | | |
| | | Min | Typ (Note 10) | Max | Min | Max | |
| t _{PHL} | Propagation Delay | 1.5 | | 3.9 | 1.5 | 4.5 | ns |
| t _{PLH} | D _n to O _n | 1.5 | | 3.9 | 1.5 | 4.5 | |
| t _{PHL} | Propagation Delay | 1.7 | | 4.2 | 1.7 | 4.9 | ns |
| t _{PLH} | LE to O _n | 1.7 | | 4.2 | 1.7 | 4.9 | |
| t _{pZL} | Output Enable Time | 1.3 | | 4.8 | 1.3 | 5.9 | ns |
| t _{pZH} | | 1.3 | | 4.8 | 1.3 | 5.5 | |
| t _{PLZ} | Output Disable Time | 1.9 | | 4.6 | 1.9 | 4.9 | ns |
| t _{PHZ} | | 1.9 | | 4.5 | 1.9 | 4.6 | |
| t _w | LE Pulse Width | 3.0 | | | 3.0 | | ns |
| t _S | Setup Time, D _n to LE | 1.1 | | | 0.4 | | ns |
| t _H | Hold Time, D _n to LE | 1.4 | | | 1.4 | | ns |

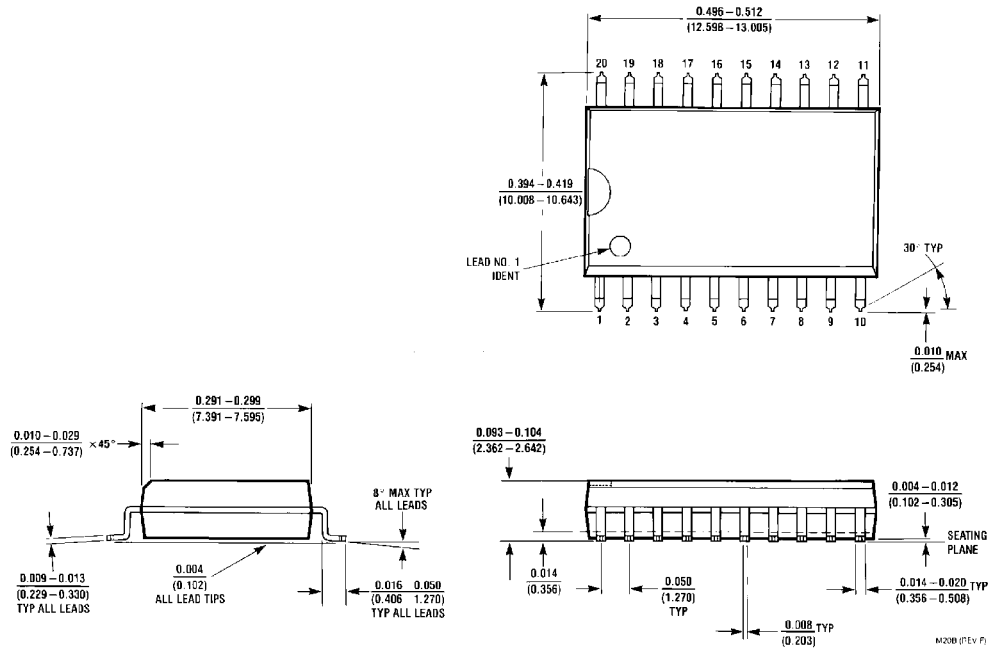
Note 10: All typical values are at V_{CC} = 3.3V, T_A = 25°C.

Capacitance (Note 11)

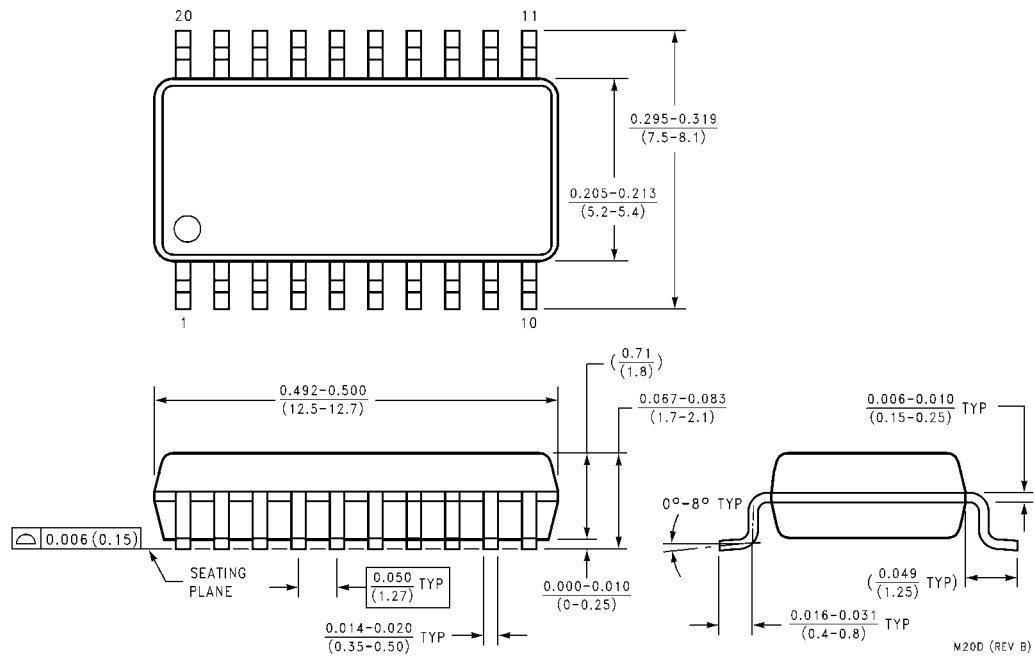
| Symbol | Parameter | Conditions | Typical | Units |
|------------------|--------------------|--|---------|-------|
| C _{IN} | Input Capacitance | V _{CC} = Open, V _I = 0V or V _{CC} | 4 | pF |
| C _{OUT} | Output Capacitance | V _{CC} = 3.0V, V _O = 0V or V _{CC} | 8 | pF |

Note 11: Capacitance is measured at frequency f = 1 MHz, per MIL-STD-883B, Method 3012.

Physical Dimensions inches (millimeters) unless otherwise noted

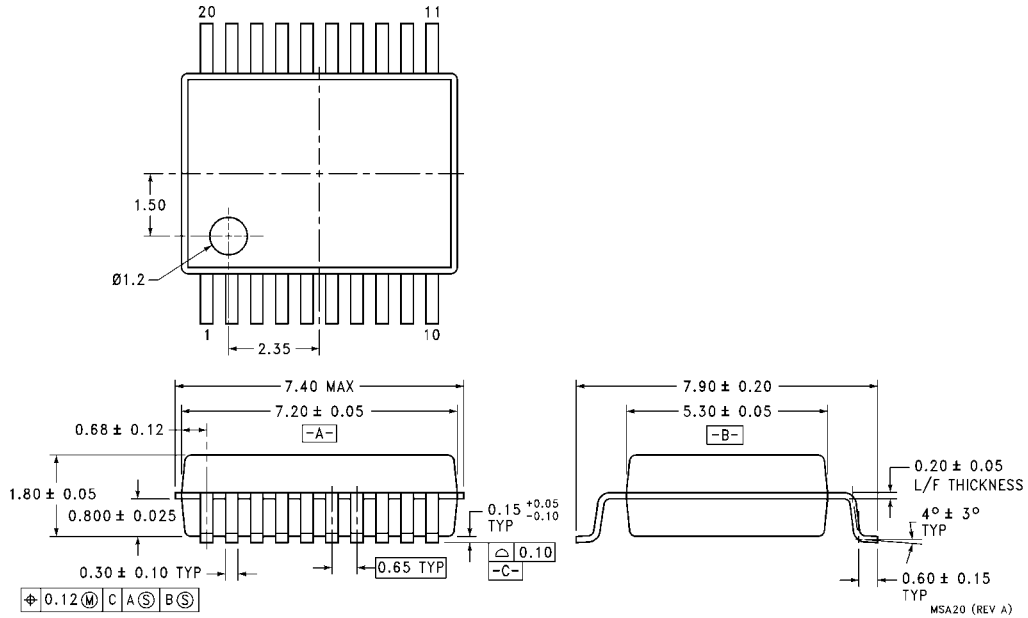


**20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
Package Number M20B**



**20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M20D**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



**20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
Package Number MSA20**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

PIN #1 IDENT.

ALL LEAD TIPS

LAND PATTERN RECOMMENDATION

DIMENSIONS ARE IN MILLIMETERS

NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20

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